

FIG. 1

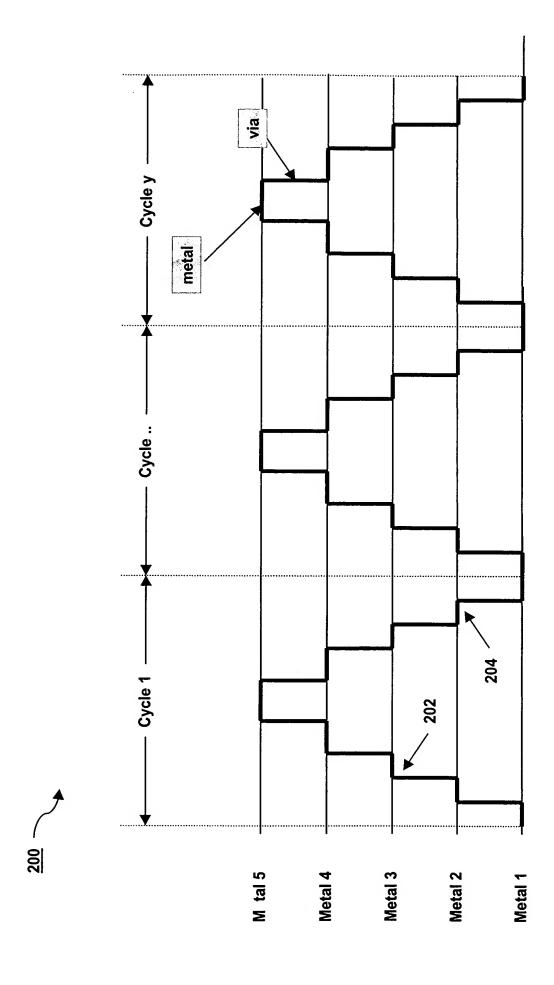
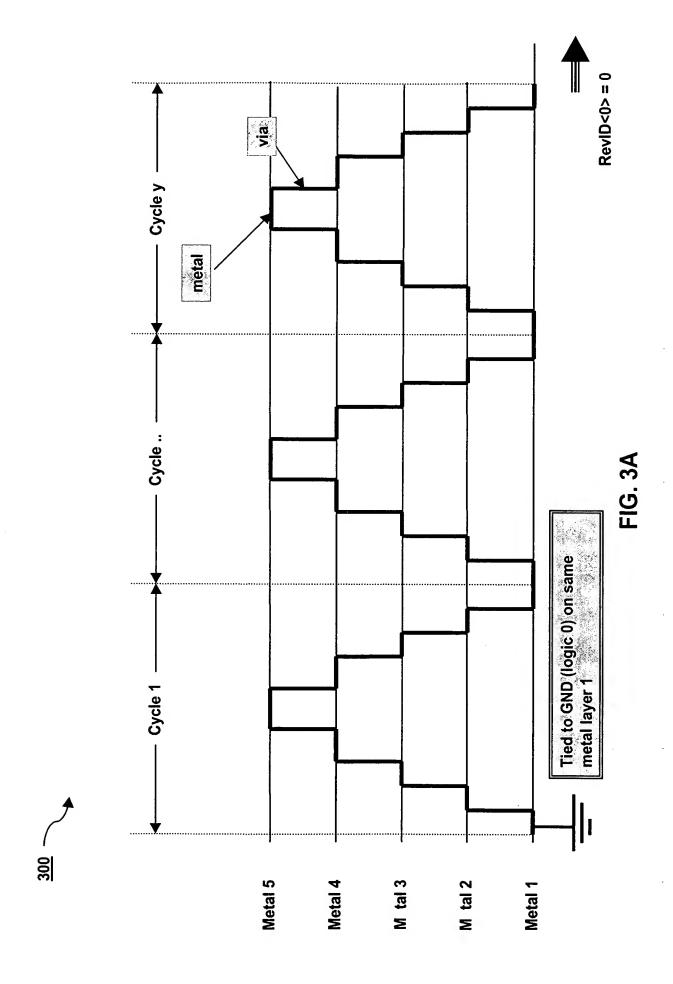
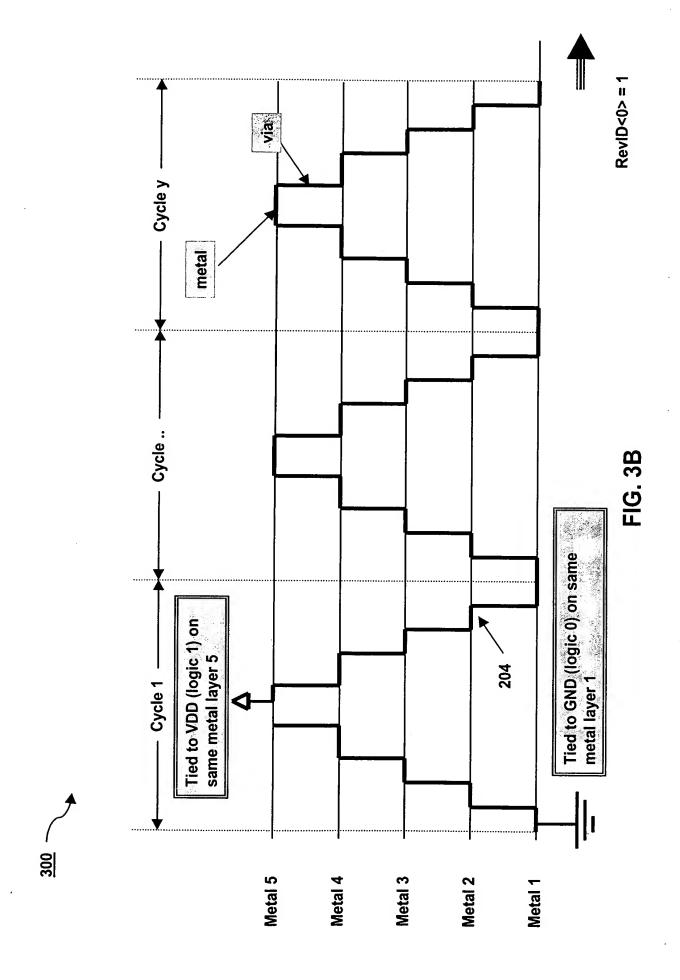
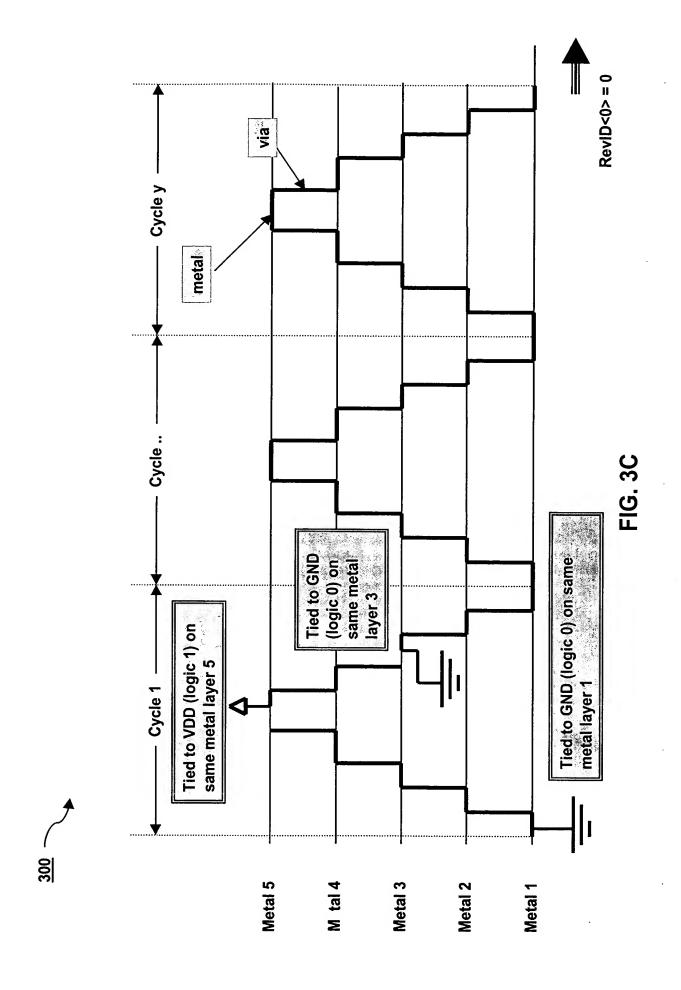


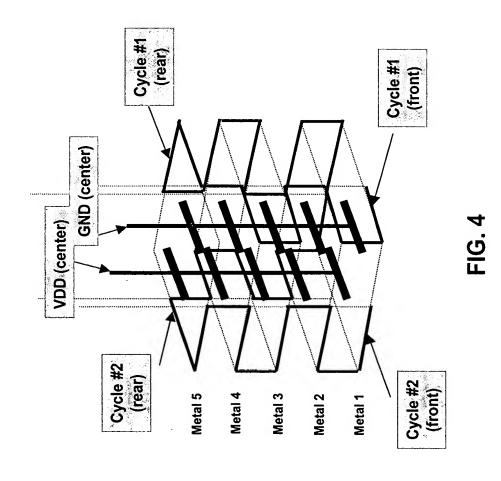
FIG. 2

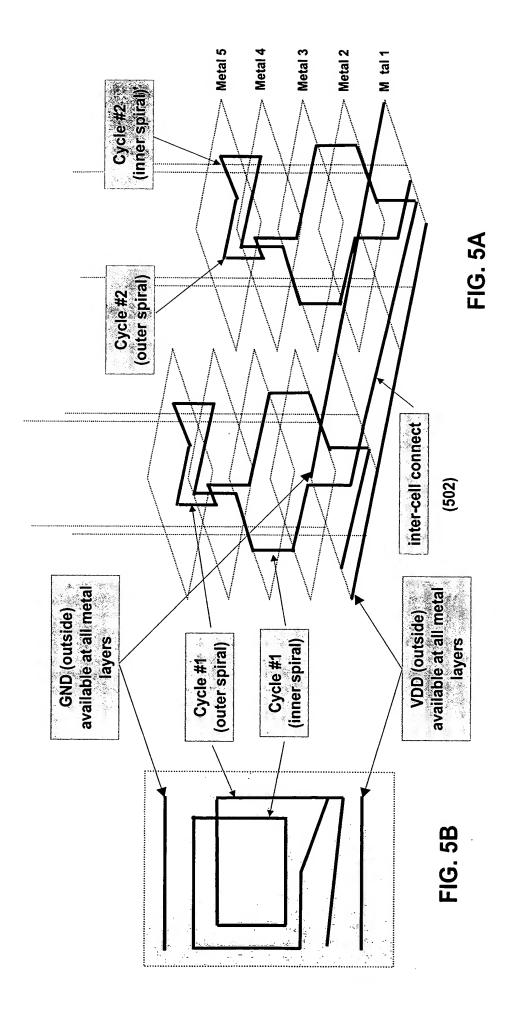












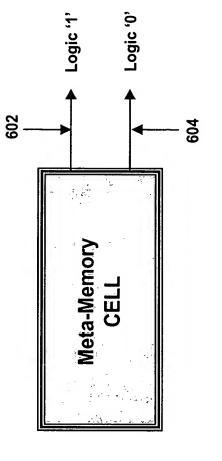


FIG. 6

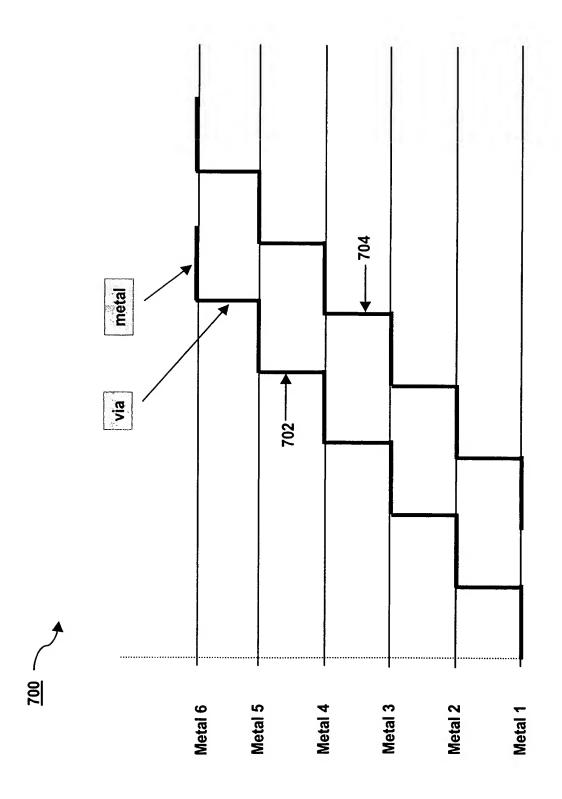


FIG. 7A

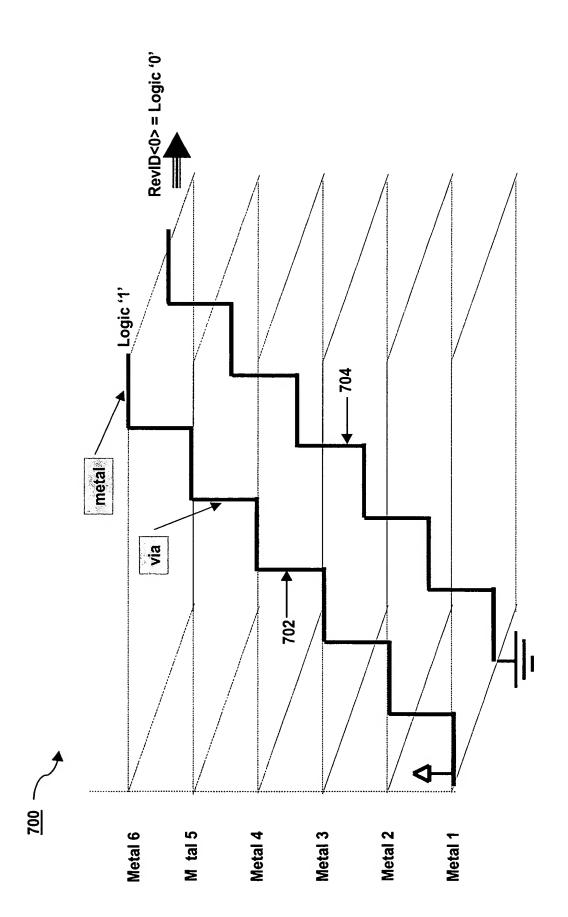
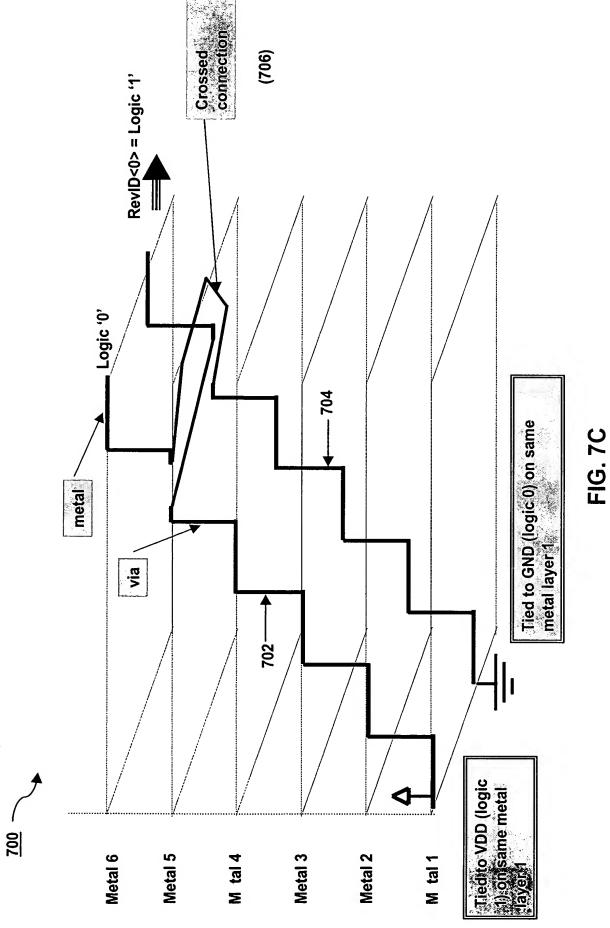
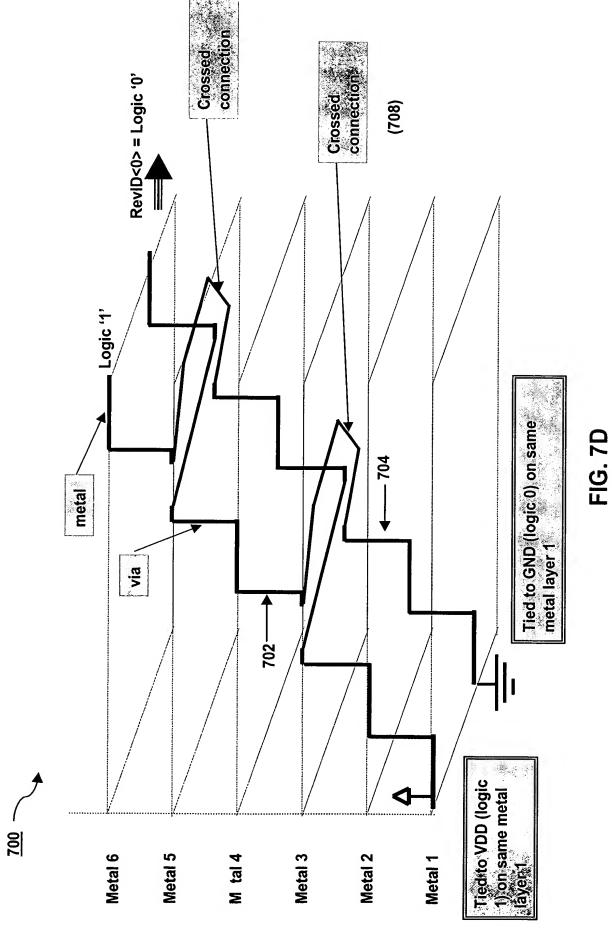
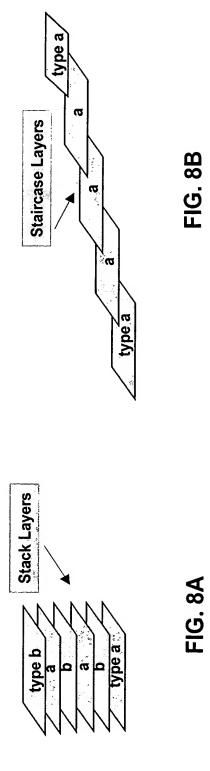
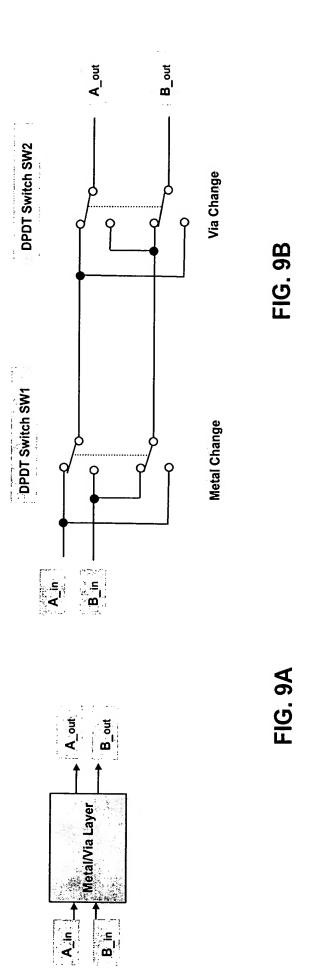


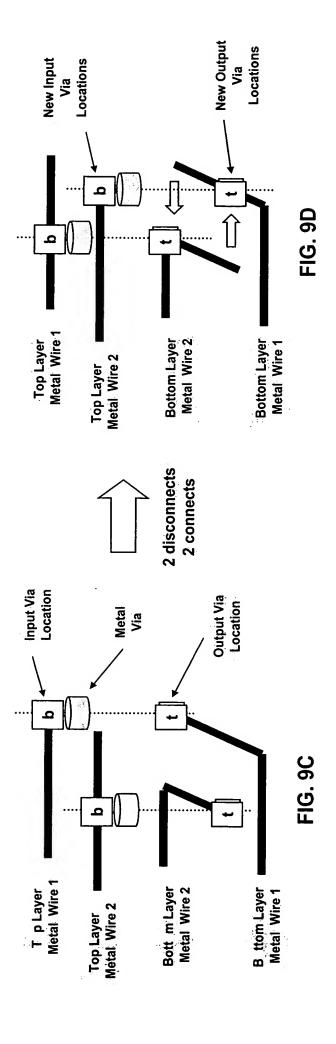
FIG. 7B











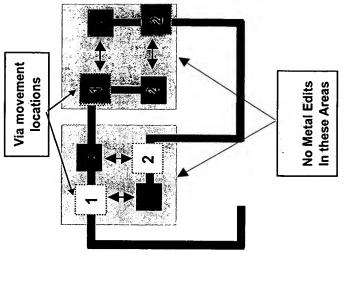


FIG. 10A

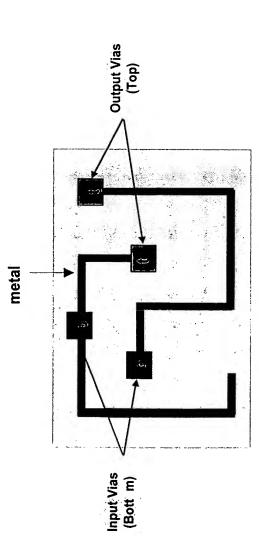


FIG. 10B

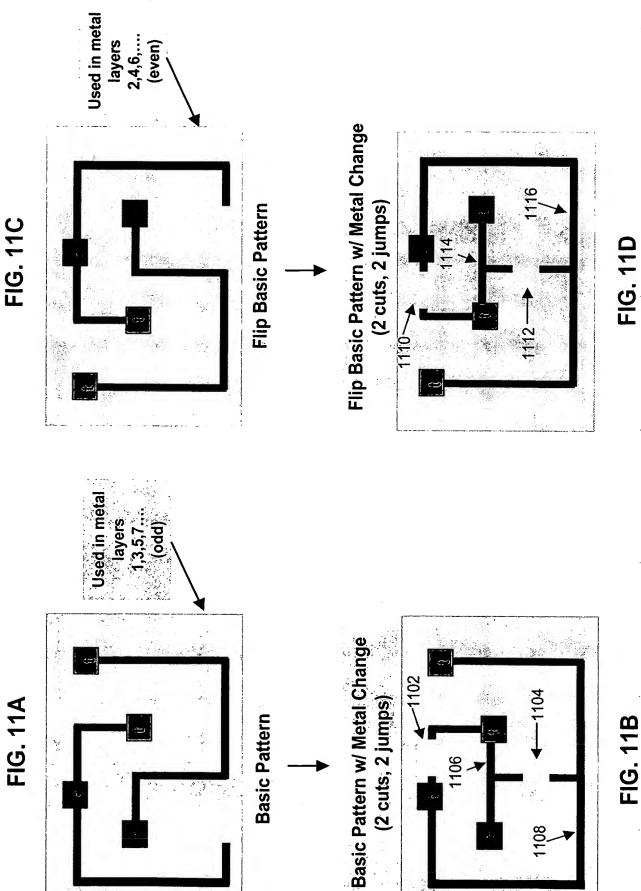
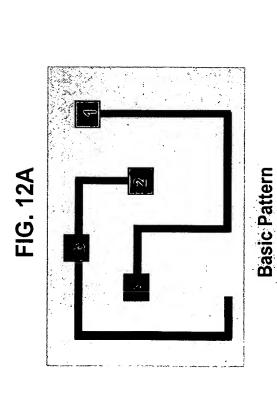


FIG. 11B



Basic Pattern w/ Via Change (2 disconnects, 2 connects)

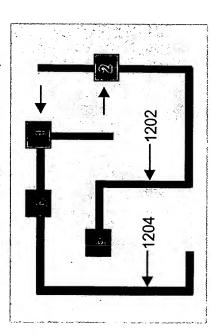
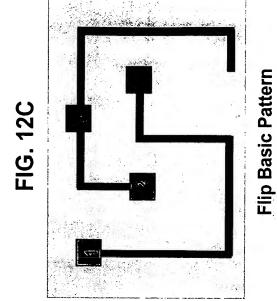


FIG. 12B



Flip Basic Pattern w/ Via Change (2 disconnects, 2 connects)

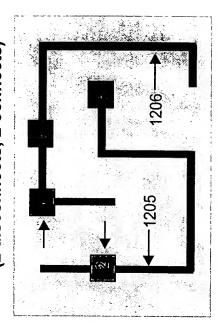
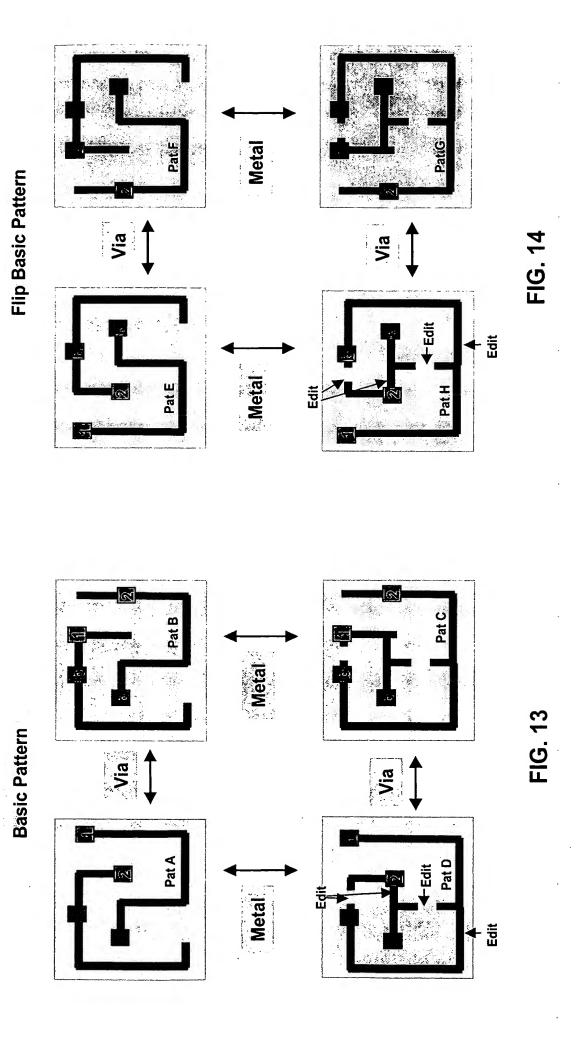
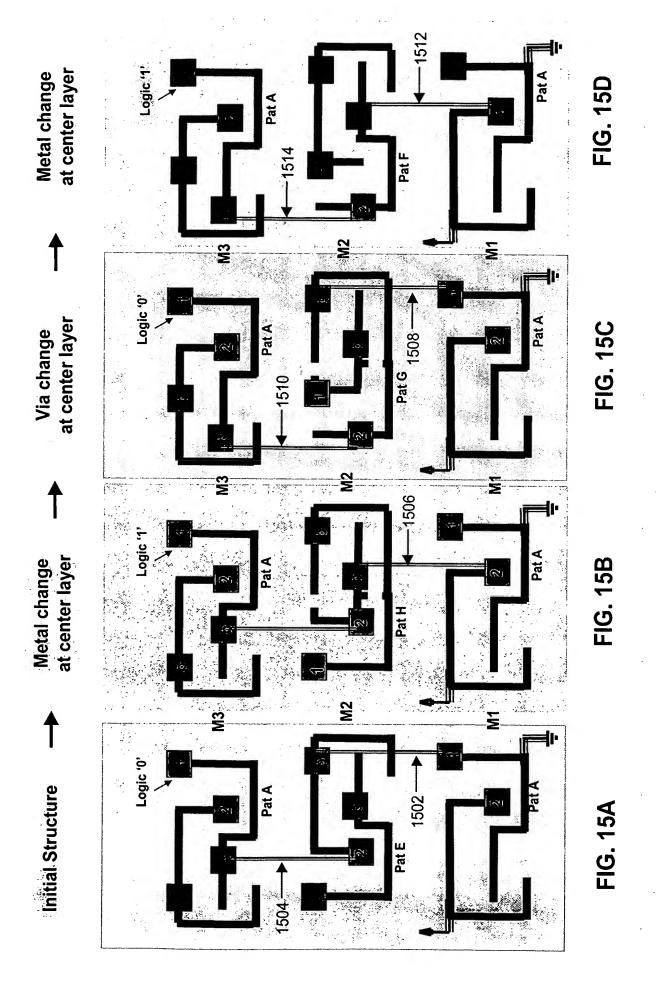


FIG. 12D





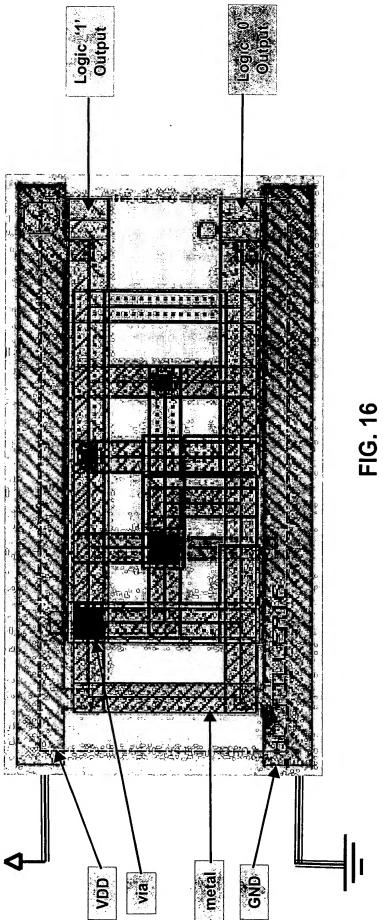


FIG. 17B

FIG. 17A

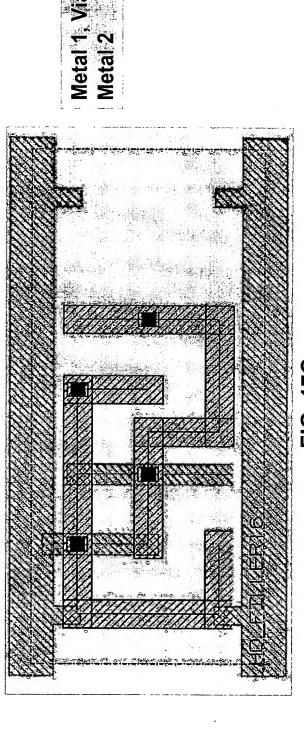


FIG. 17C

FIG. 18B

FIG. 18A

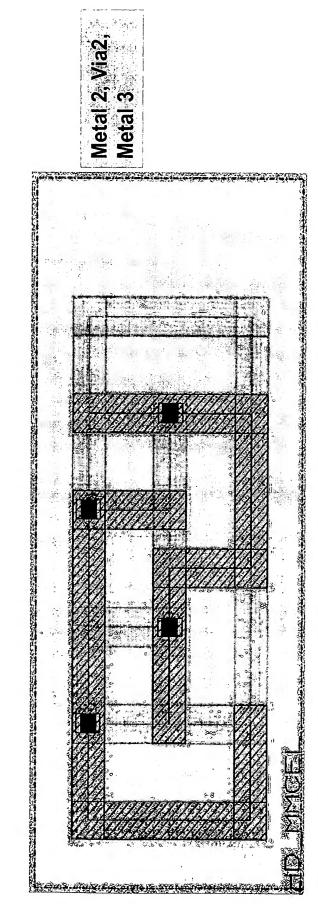


FIG. 18C

Metal 3, Via3, Metal 4

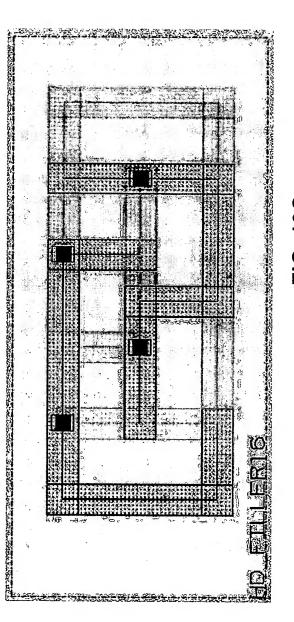


FIG. 19C

Metall 4, Via4, Metall 5 THE STATE OF THE S Metal 4, Via4 HOLETLLERIG

FIG. 20B

FIG. 20A

Metal 5

FIG. 20C

Metal 6 Metal 5, Via5

FIG. 21B

FIG. 21A

Metal 5, Via5, Metal 6

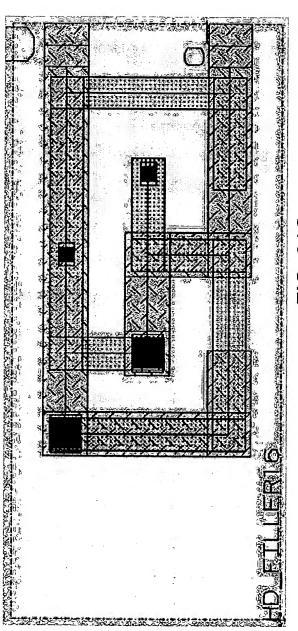


FIG. 21C

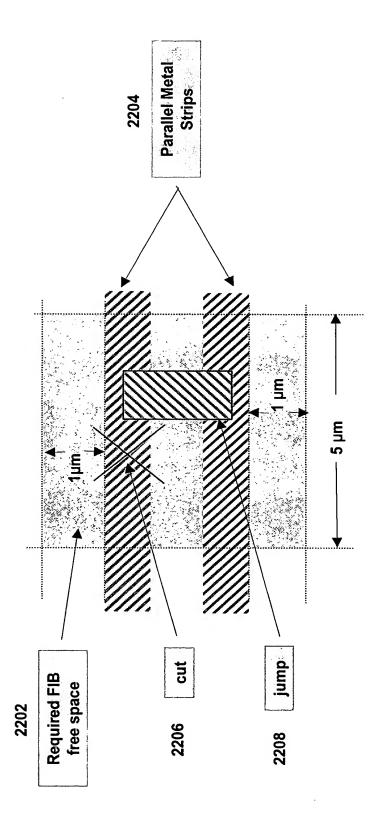


FIG. 22